

#### Features

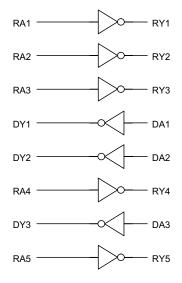
- Single-chip with easy interface between UART and serial port connector
- Three drivers and five receivers meet or exceed the requirements of EIA/TIA-232-D
- · Designed to support data rates up to 120 Kbit/s
- General Description

The HT6571 is a CMOS device containing three RS-232 line drivers, and five RS-232 line receivers that are used

- Driver current-limited output: 25mA typ.
- Flexible supply voltage range
- ESD protection exceeds 5kV
- 20-pin SOP package

to interface data terminal equipment (DTE) with data circuit-terminating equipment (DCE).

## **Block Diagram**



# **Pin Assignment**

	1		$\nabla$		I I	
VDD		1	-	20		VCC
RA1		2		19	Þ	RY1
RA2		3		18	Þ	RY2
RA3		4		17		RY3
DY1		5		16		DA1
DY2		6		15	Þ	DA2
RA4		7		14		RY4
DY3		8		13		DA3
RA5		9		12		RY5
VSS		10		11	Þ	GND
HT6571						
- 20 SOP-A						

### Absolute Maximum Ratings

Supply Voltage (VSS VDD)15V~15	V
Input Voltage Driver 0V~7	V
Output Voltage Driver15V~15	V

Supply Voltage (GND VCC)	. –0.3V~5.5V
Receiver	–15V <b>~</b> 15V
Receiver	0V~7V

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.



## **Electrical Characteristics**

Symbol	Paremeter	Test Conditions			Min	Turn	Max	Unit
Symbol	Faremeter	V <sub>DD</sub>	V <sub>CC</sub>	Conditions	Min.	Тур.	Max.	Unit
V <sub>DD</sub>	Operation Voltage	_	_		7.5	9	15	V
V <sub>SS</sub>	Operation Voltage	_	_		-7.5	-9	-15	V
V <sub>CC</sub>	Operation Voltage	_			4.5	5	5.5	V
V <sub>IH1</sub>	Driver Input High	12V	5V		2	_	_	V
V <sub>IL1</sub>	Driver Input Low	12V	5V		_	_	0.8	V
V <sub>IH2</sub>	Receiver Input High	12V	5V		3	_	_	V
V <sub>IL2</sub>	Receiver Input Low	12V	5V		_	_	0	V
I <sub>OH1</sub>	Receiver Output Source Current	12V	5V	V <sub>0</sub> =2.4V	-1	-2	-3	mA
I <sub>OL1</sub>	Receiver Output Sink Current	12V	5V	V <sub>O</sub> =0.4V	+1	+2	+3	mA
I <sub>OS(H)</sub>	High-level Driver Short Current	12V	5V	V <sub>O</sub> =0V	-15	-25	-35	mA
I <sub>OS(L)</sub>	Low-level Driver Short Current	12V	5V	V <sub>O</sub> =0V	15	25	35	mA
S <sub>R1</sub>	Slew Rate	12V	5V	$R_L=7k\Omega$ , $C_1=330pF$		_	30	V/µs

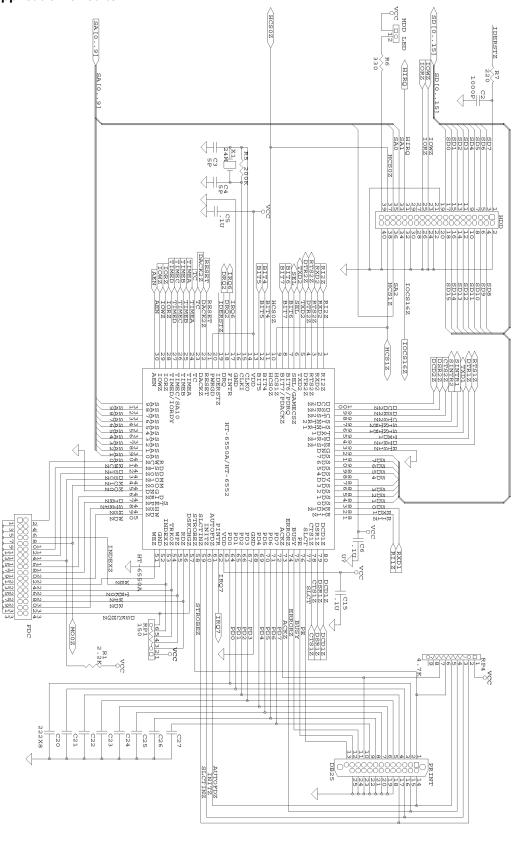
Rev. 1.20

August 20, 2002

2



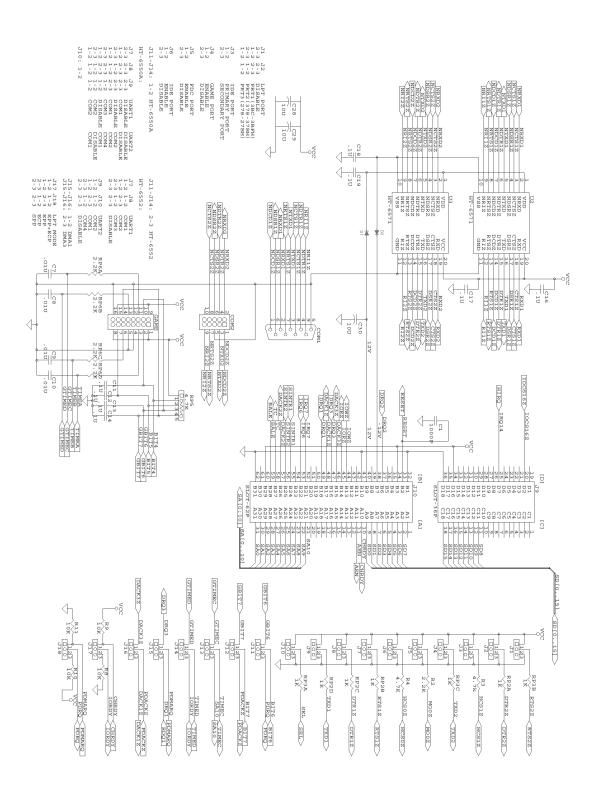
### **Application Circuits**



Rev. 1.20

3

August 20, 2002



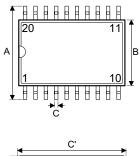
4

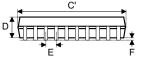
HOLTEK



## **Package Information**

20-pin SOP (300mil) outline dimensions





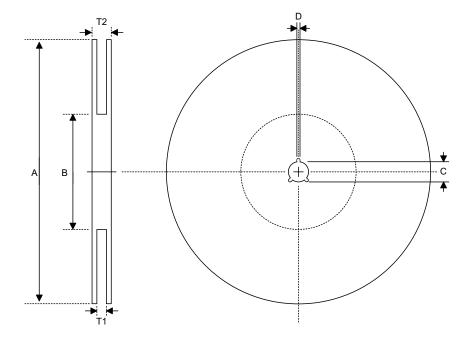


Symbol	Dimensions in mil				
Symbol	Min.	Nom.	Max.		
A	394	_	419		
В	290	_	300		
С	14	_	20		
C'	490		510		
D	92	_	104		
E		50	—		
F	4	_	_		
G	32	_	38		
Н	4	_	12		
α	0°		10°		



# **Product Tape and Reel Specifications**

## **Reel dimensions**

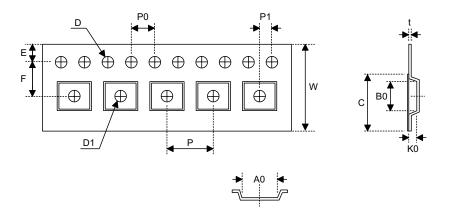


### SOP 20W

Symbol	Description	Dimensions in mm
А	Reel Outer Diameter	330±1.0
В	Reel Inner Diameter	62±1.5
с	Spindle Hole Diameter	13.0+0.5 0.2
D	Key Slit Width	2.0±0.5
T1	Space Between Flange	24.8+0.3 0.2
T2	Reel Thickness	30.2±0.2



### Carrier tape dimensions



### SOP 20W

Symbol	Description	Dimensions in mm
W	Carrier Tape Width	24.0+0.3 -0.1
Р	Cavity Pitch	12.0±0.1
Е	Perforation Position	1.75±0.1
F	Cavity to Perforation (Width Direction)	11.5±0.1
D	Perforation Diameter	1.5+0.1
D1	Cavity Hole Diameter	1.5+0.25
P0	Perforation Pitch	4.0±0.1
P1	Cavity to Perforation (Length Direction)	2.0±0.1
A0	Cavity Length	10.8±0.1
В0	Cavity Width	13.3±0.1
K0	Cavity Depth	3.2±0.1
t	Carrier Tape Thickness	0.3±0.05
С	Cover Tape Width	21.3



Holtek Semiconductor Inc. (Headquarters) No.3, Creation Rd. II, Science Park, Hsinchu, Taiwan Tel: 886-3-563-1999

Fax: 886-3-563-1189 http://www.holtek.com.tw

#### Holtek Semiconductor Inc. (Taipei Sales Office)

4F-2, No. 3-2, YuanQu St., Nankang Software Park, Taipei 115, Taiwan Tel: 886-2-2655-7070 Fax: 886-2-2655-7373 Fax: 886-2-2655-7383 (International sales hotline)

#### Holtek Semiconductor Inc. (Shanghai Sales Office)

7th Floor, Building 2, No.889, Yi Shan Rd., Shanghai, China 200233 Tel: 021-6485-5560 Fax: 021-6485-0313 http://www.holtek.com.cn

#### Holtek Semiconductor Inc. (Shenzhen Sales Office)

5/F, Unit A, Productivity Building, Cross of Science M 3rd Road and Gaoxin M 2nd Road, Science Park, Nanshan District, Shenzhen, China 518057 Tel: 0755-8616-9908, 8616-9308 Fax: 0755-8616-9533

#### Holtek Semiconductor Inc. (Beijing Sales Office)

Suite 1721, Jinyu Tower, A129 West Xuan Wu Men Street, Xicheng District, Beijing, China 100031 Tel: 010-6641-0030, 6641-7751, 6641-7752 Fax: 010-6641-0125

#### Holtek Semiconductor Inc. (Chengdu Sales Office)

709, Building 3, Champagne Plaza, No.97 Dongda Street, Chengdu, Sichuan, China 610016 Tel: 028-6653-6590 Fax: 028-6653-6591

#### Holmate Semiconductor, Inc. (North America Sales Office)

46729 Fremont Blvd., Fremont, CA 94538 Tel: 510-252-9880 Fax: 510-252-9885 http://www.holmate.com

#### Copyright © 2002 by HOLTEK SEMICONDUCTOR INC.

The information appearing in this Data Sheet is believed to be accurate at the time of publication. However, Holtek assumes no responsibility arising from the use of the specifications described. The applications mentioned herein are used solely for the purpose of illustration and Holtek makes no warranty or representation that such applications will be suitable without further modification, nor recommends the use of its products for application that may present a risk to human life due to malfunction or otherwise. Holtek's products are not authorized for use as critical components in life support devices or systems. Holtek reserves the right to alter its products without prior notification. For the most up-to-date information, please visit our web site at http://www.holtek.com.tw.